

# 6MBP15VAA120-50

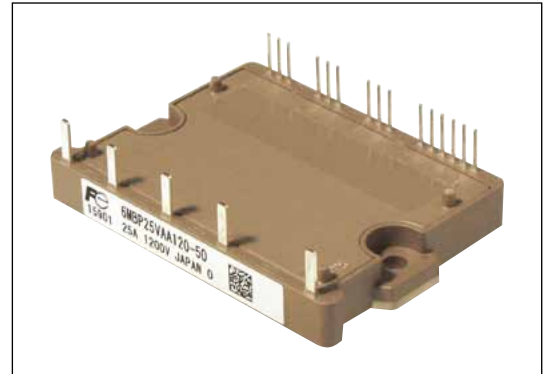
IGBT Modules

## IGBT MODULE (V series)

### 1200V / 15A / IPM

#### ■ Features

- Temperature protection provided by directly detecting the junction temperature of the IGBTs
- Low power loss and soft switching
- High performance and high reliability IGBT with overheating protection
- Higher reliability because of a big decrease in number of parts in built-in control circuit



#### ■ Maximum Ratings and Characteristics

##### ● Absolute Maximum Ratings (T<sub>c</sub>=25°C, V<sub>cc</sub>=15V unless otherwise specified)

Items	Symbol	Min.	Max.	Units
Collector-Emitter Voltage (*1)	V <sub>CEs</sub>	0	1200	V
Short Circuit Voltage	V <sub>sc</sub>	400	800	V
Collector Current	DC	I <sub>c</sub>	15	A
	1ms	I <sub>cp</sub>	30	A
	Duty=89% (*2)	-I <sub>c</sub>	15	A
Collector Power Dissipation	1 device (*3)	P <sub>c</sub>	122	W
Supply Voltage of Pre-Driver (*4)	V <sub>cc</sub>	-0.5	20	V
Input Signal Voltage (*5)	V <sub>in</sub>	-0.5	V <sub>cc</sub> +0.5	V
Alarm Signal Voltage (*6)	V <sub>ALM</sub>	-0.5	V <sub>cc</sub>	V
Alarm Signal Current (*7)	I <sub>ALM</sub>	-	20	mA
Junction Temperature	T <sub>j</sub>	-	150	°C
Operating Case Temperature	T <sub>opr</sub>	-20	110	°C
Storage Temperature	T <sub>stg</sub>	-40	125	°C
Solder Temperature (*8)	T <sub>sol</sub>	-	260	°C
Isolating Voltage (*9)	V <sub>iso</sub>	-	AC2500	Vrms
Screw Torque	Mounting (M4)	-	1.7	Nm

Note \*1: V<sub>CEs</sub> shall be applied to the input voltage between terminal P-(U,V, W) and (U,V, W)-N.

Note \*2: Duty=125°C/R<sub>th(j-cj)</sub> / (I<sub>F</sub>×V<sub>F Max.</sub>)×100

Note \*3: P<sub>c</sub>=125°C/R<sub>th(j-cj)</sub>

Note \*4: V<sub>cc</sub> shall be applied to the input voltage between terminal No.3 and 1, 6 and 4, 9 and 7,11 and 10.

Note \*5: V<sub>in</sub> shall be applied to the input voltage between terminal No.2 and 1, 5 and 4, 8 and 7,12-14 and 10.

Note \*6: V<sub>ALM</sub> shall be applied to the voltage between terminal No.15 and 10.

Note \*7: I<sub>ALM</sub> shall be applied to the input current to terminal No.15.

Note \*8: Immersion time 10±1sec. 1time

Note \*9: Terminal to base, 50/60Hz sine wave 1min. All terminals should be connected together during the test.

● Electrical Characteristics ( $T_J=25^\circ\text{C}$ ,  $V_{CC}=15\text{V}$  unless otherwise specified)

Items	Symbol	Conditions	Min.	Typ.	Max.	Units		
Inverter	Collector Current at off signal input	$I_{CES}$	$V_{CE}=1200\text{V}$		-	-	1.0	mA
	Collector-Emitter saturation voltage	$V_{CE(sat)}$	$I_C=15\text{A}$	Terminal	-	-	2.05	V
				Chip	-	1.68	-	V
	Forward voltage of FWD	$V_F$	$I_F=15\text{A}$	Terminal	-	-	2.50	V
Chip				-	2.10	-	V	
Switching time	$t_{on}$	$V_{DC}=600\text{V}$ , $T_J=125^\circ\text{C}$ , $I_C=15\text{A}$	1.1	-	-	$\mu\text{s}$		
	$t_{off}$		-	-	2.1	$\mu\text{s}$		
	$t_{rr}$	$V_{DC}=600\text{V}$ , $I_C=15\text{A}$	-	-	0.3	$\mu\text{s}$		
Supply current of P-side pre-driver (per one unit)	$I_{ccp}$	Switching Frequency= 0-15kHz	-	-	8	mA		
Supply current of N-side pre-driver	$I_{ccn}$	$T_C=-20\sim 110^\circ\text{C}$	-	-	19	mA		
Input signal threshold voltage	$V_{in(th)(on)}$	$V_{in-GND}$	ON	1.2	1.4	1.6	V	
	$V_{in(th)(off)}$		OFF	1.5	1.7	1.9	V	
Over Current Protection Level	$I_{OC}$	$T_J=125^\circ\text{C}$	23	-	-	A		
Over Current Protection Delay time	$t_{dOC}$	$T_J=125^\circ\text{C}$	-	5	-	$\mu\text{s}$		
Short Circuit Protection Delay time	$t_{SC}$	$T_J=125^\circ\text{C}$	-	2	3	$\mu\text{s}$		
IGBT Chips Over Heating Protection Temperature Level	$T_{J(OH)}$	Surface of IGBT Chips	150	-	-	$^\circ\text{C}$		
Over Heating Protection Hysteresis	$T_{JH}$		-	20	-	$^\circ\text{C}$		
Under Voltage Protection Level	$V_{UV}$		11.0	-	12.5	V		
Under Voltage Protection Hysteresis	$V_H$		0.2	0.5	-	V		
Alarm Signal Hold Time	$t_{ALM(OC)}$	ALM-GND $T_C=-20\sim 110^\circ\text{C}$	$V_{CC}\geq 10\text{V}$	1.0	2.0	2.4	ms	
	$t_{ALM(UV)}$			2.5	4.0	4.9	ms	
	$t_{ALM(TJ(OH))}$			5.0	8.0	11.0	ms	
Resistance for current limit	$R_{ALM}$		960	1265	1570	$\Omega$		

● Thermal Characteristics ( $T_c = 25^\circ\text{C}$ )

Items		Symbol	Min.	Typ.	Max.	Units
Junction to Case Thermal Resistance (*10)	Inverter	$R_{th(j-c)Q}$	-	-	1.02	$^\circ\text{C/W}$
	IGBT	$R_{th(j-c)D}$	-	-	1.51	$^\circ\text{C/W}$
Case to Fin Thermal Resistance with Compound	FWD	$R_{th(c-f)}$	-	0.05	-	$^\circ\text{C/W}$

Note \*10: For 1device, the measurement point of the case is just under the chip.

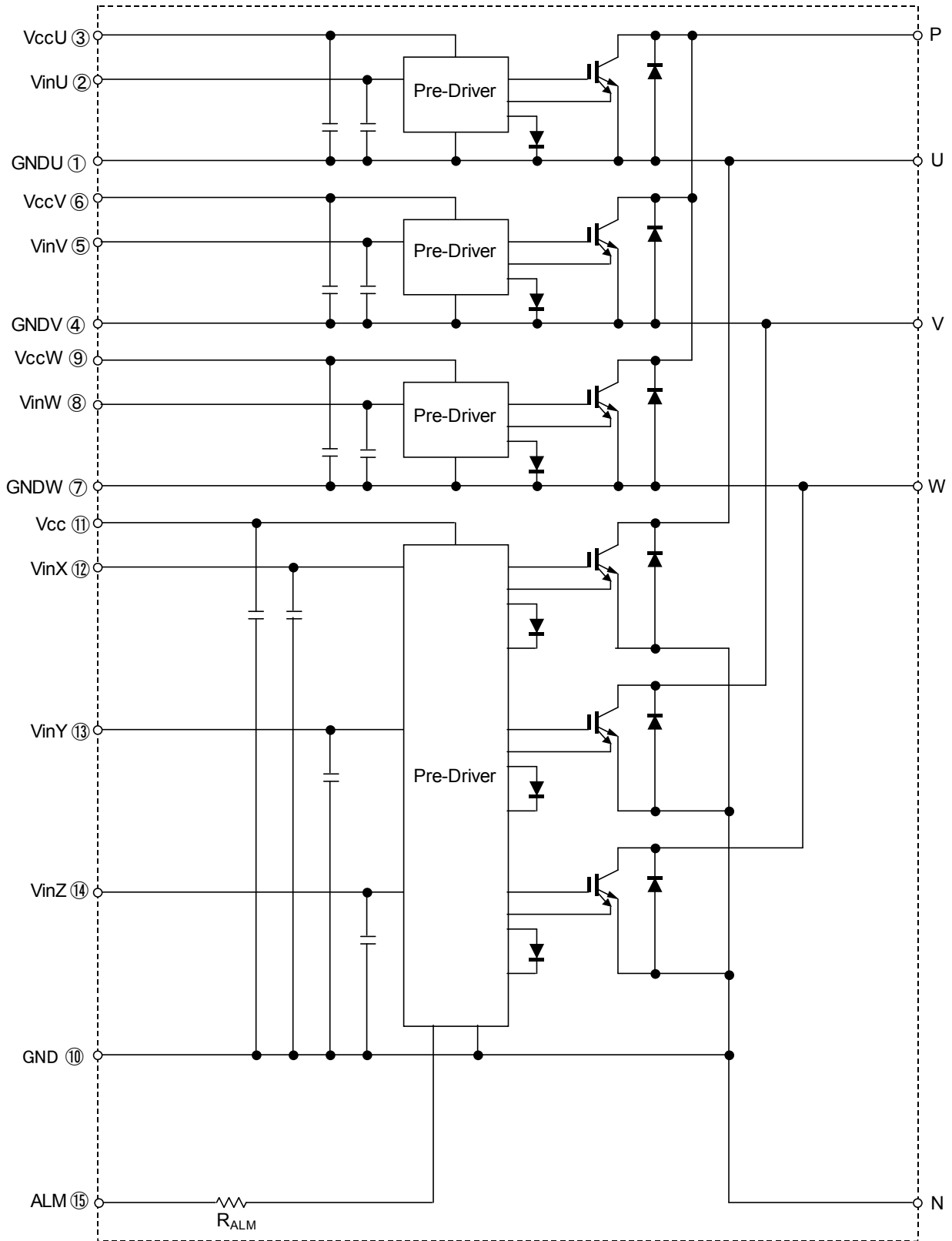
● Noise Immunity ( $V_{DC}=600\text{V}$ ,  $V_{CC}=15\text{V}$ )

Items	Conditions	Min.	Typ.	Max.	Units
Common mode rectangular noise	Pulse width $1\mu\text{s}$ , polarity $\pm$ , 10 min. Judge : no over-current, no miss operating	$\pm 2.0$	-	-	kV

● Recommended Operating Conditions

Items	Symbol	Min.	Typ.	Max.	Units
DC Bus Voltage	$V_{DC}$	-	-	800	V
Power Supply Voltage of Pre-Driver	$V_{CC}$	13.5	15.0	16.5	V
Switching frequency of IPM	$f_{SW}$	-	-	20	kHz
Arm shoot through blocking time for IPM's input signal	$t_{dead}$	1.0	-	-	$\mu\text{s}$
Screw Torque (M4)	-	1.3	-	1.7	Nm

■ Block Diagram

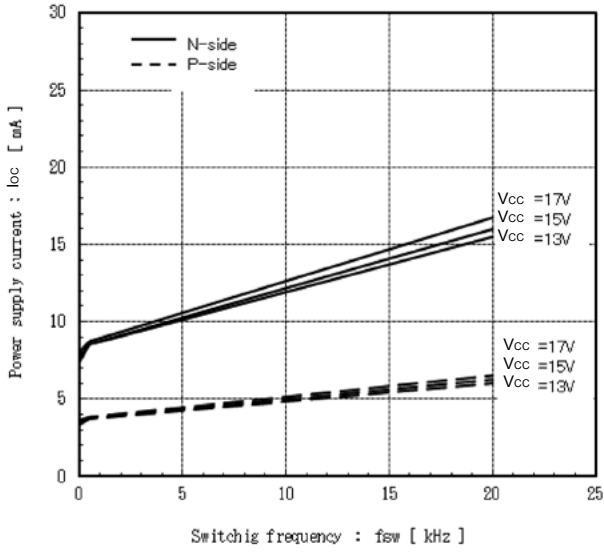


Pre-drivers include following functions

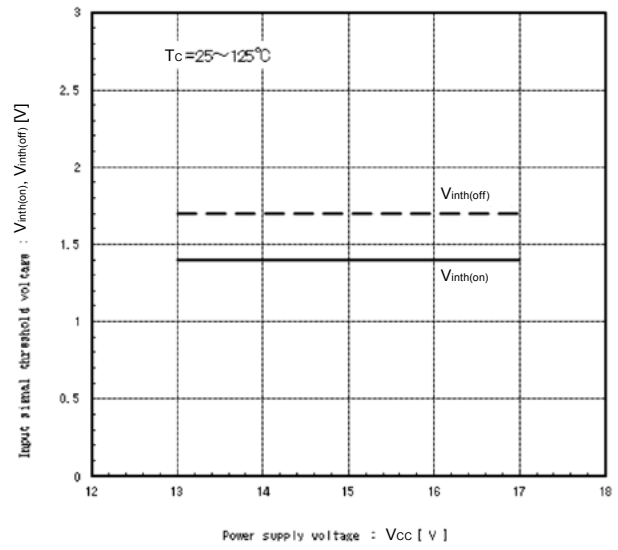
1. Amplifier for driver
2. Short circuit protection
3. Under voltage lockout circuit
4. Over current protection
5. IGBT chip over heating protection

■ Characteristics (Representative)

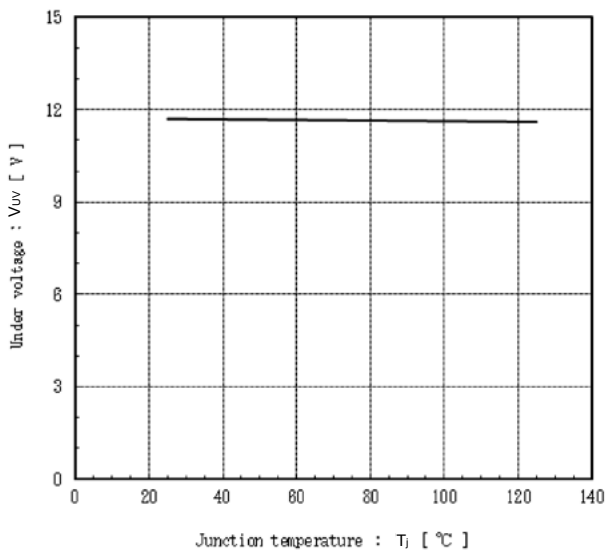
Power supply current vs. Switching frequency  
 $T_j = 25^\circ\text{C}$  (typ.)



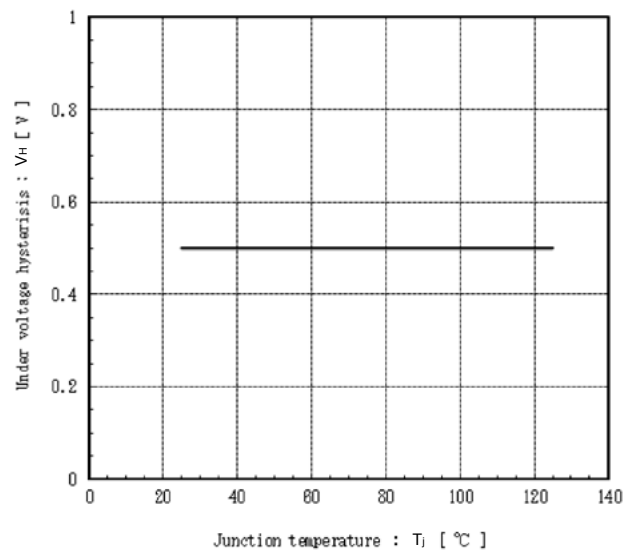
Input signal threshold voltage vs. Power supply voltage (typ.)



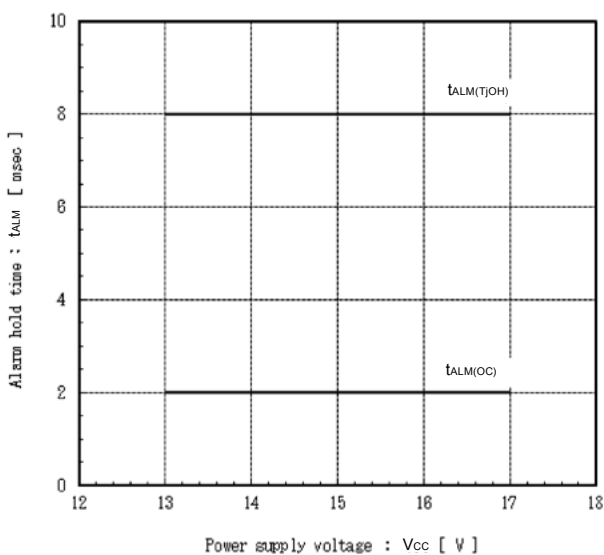
Under voltage vs. Junction temperature (typ.)



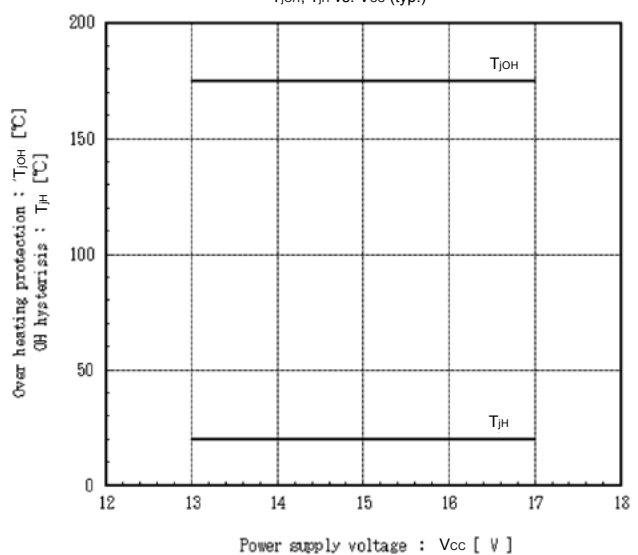
Under voltage hysteresis vs. Junction temperature (typ.)



Alarm hold time vs. Power supply voltage (typ.)

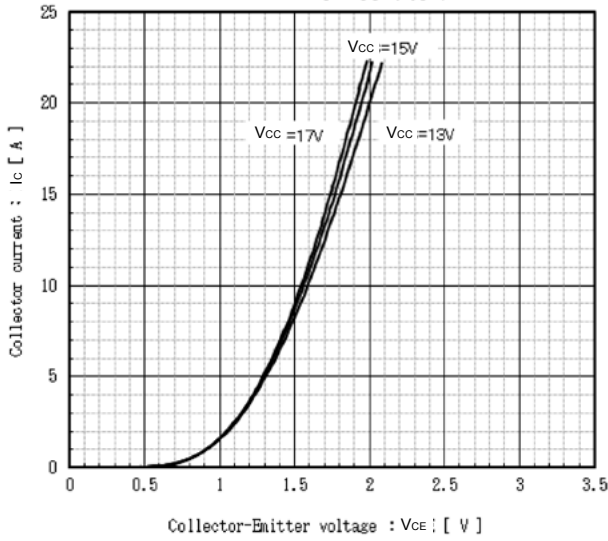


Over heating characteristics  
 $T_{jOH}, T_{jH}$  vs.  $V_{cc}$  (typ.)

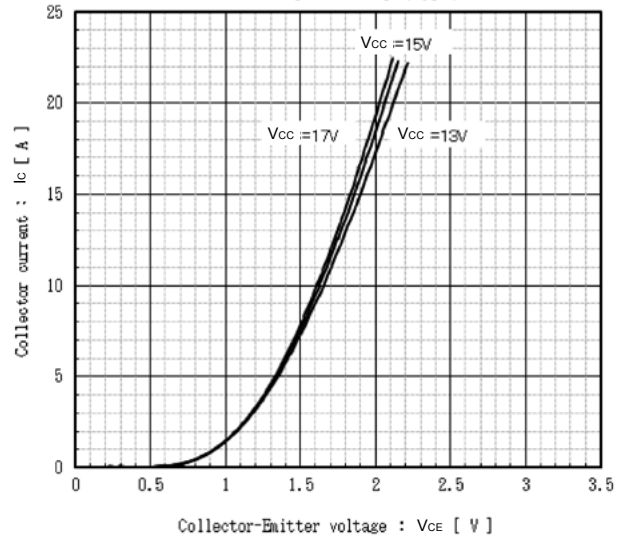


Inverter

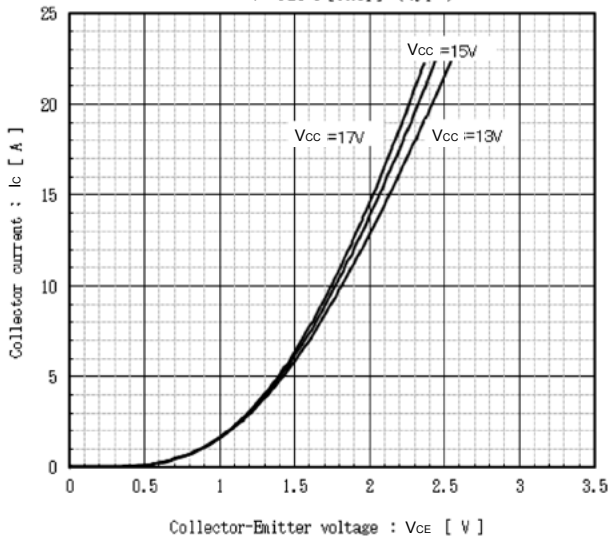
Collector current vs. Collector-Emittter voltage  
 $T_j = 25^\circ\text{C}$  [Chip] (typ.)



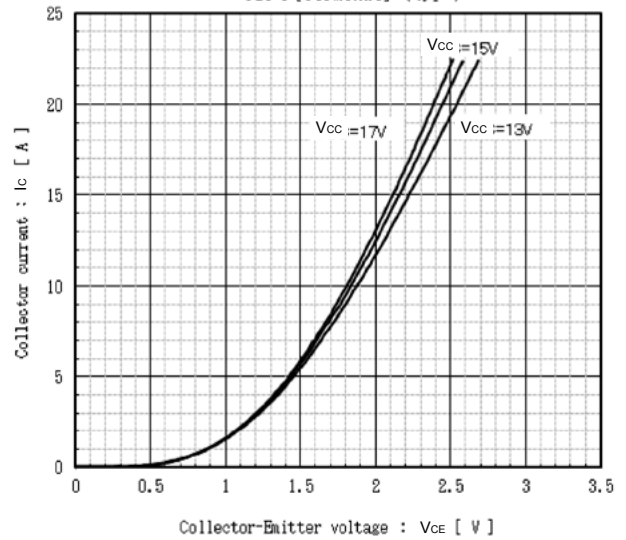
Collector current vs. Collector-Emittter voltage  
 $T_j = 25^\circ\text{C}$  [Terminal] (typ.)



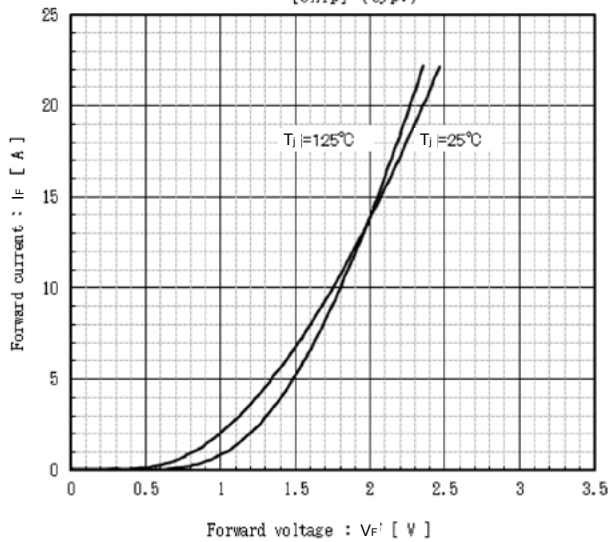
Collector current vs. Collector-Emittter voltage  
 $T_j = 125^\circ\text{C}$  [Chip] (typ.)



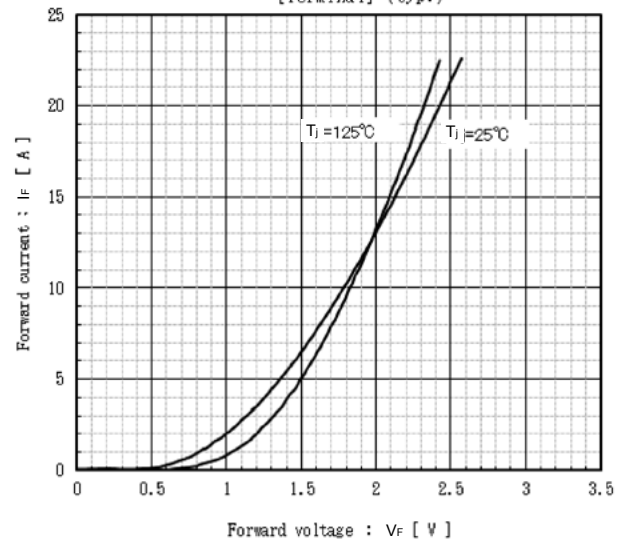
Collector current vs. Collector-Emittter voltage  
 $T_j = 125^\circ\text{C}$  [Terminal] (typ.)



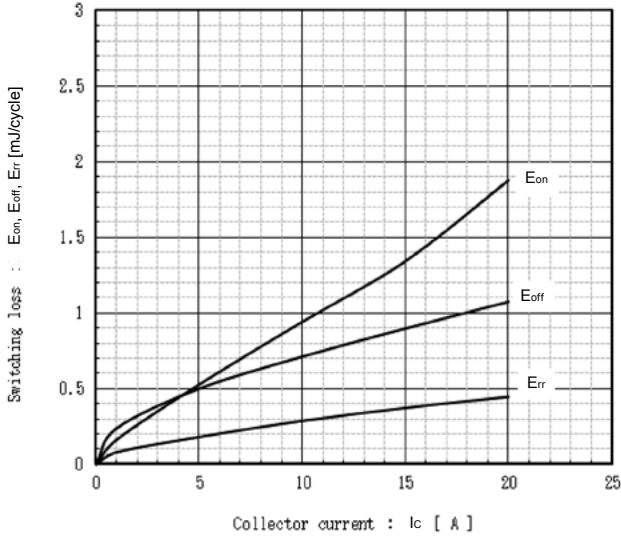
Forward current vs. Forward voltage  
 [Chip] (typ.)



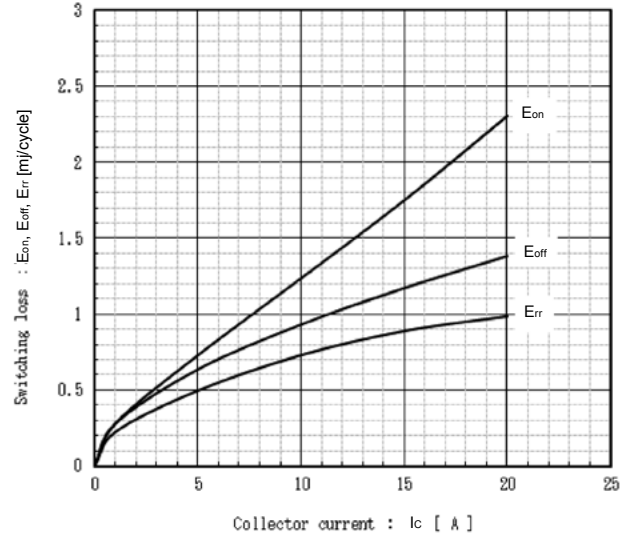
Forward current vs. Forward voltage  
 [Terminal] (typ.)



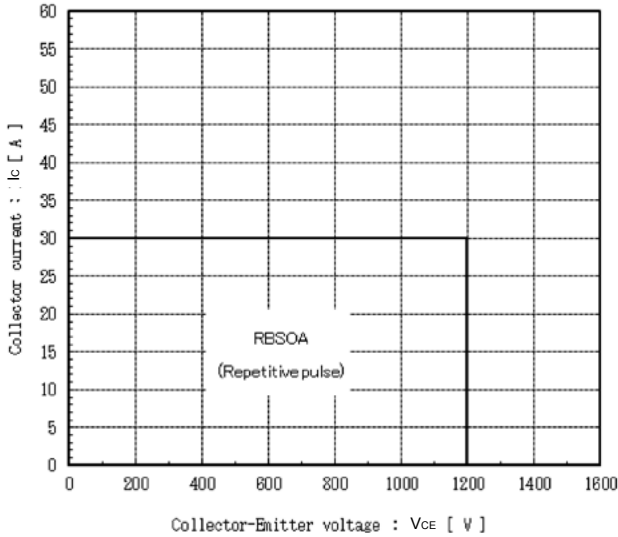
Switching Loss vs. Collector Current (typ.)  
 $V_{bc}=600V, V_{cc}=15V, T_j=25^\circ C$



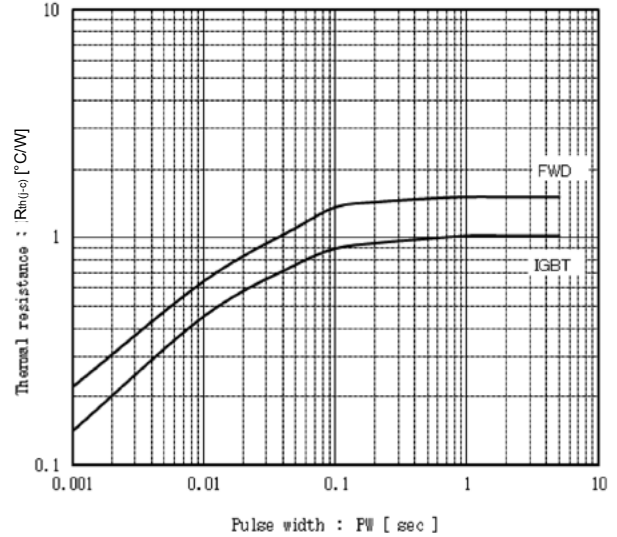
Switching Loss vs. Collector Current (typ.)  
 $V_{bc}=600V, V_{cc}=15V, T_j=125^\circ C$



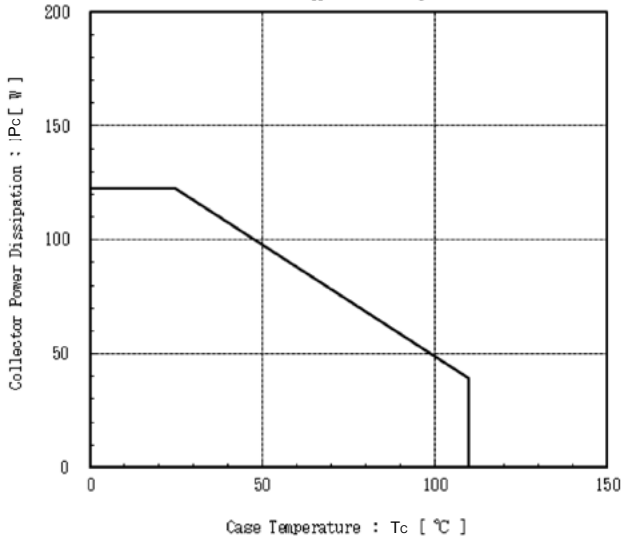
Reversed biased safe operating area  
 $V_{cc}=15V, T_j \le 125^\circ C$  [Main Terminal] (min.)



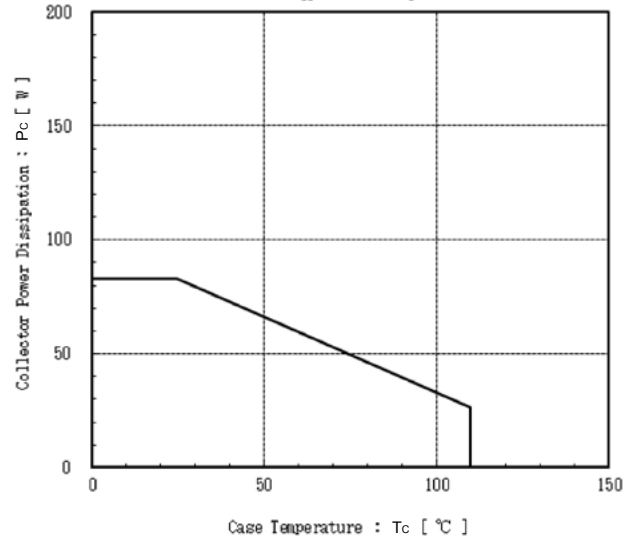
Transient thermal resistance (max.)



Power derating for IGBT (max.)  
 [per device]



Power derating for FWD (max.)  
 [per device]





**WARNING**

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• Machine tools	• Audiovisual equipment	• Electrical home appliances	• Personal equipment
			• Industrial robots etc.
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• Traffic-signal control equipment	• Gas leakage detectors with an auto-shut-off feature
• Emergency equipment for responding to disasters and anti-burglary devices	• Safety devices
• Medical equipment	
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• Submarine repeater equipment		
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